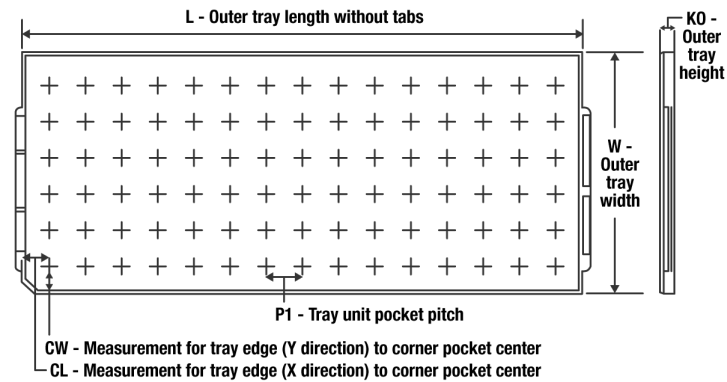


Carrier Material Report for OMAPL137DZKB4

Tray Information:



Device	Package Drawing	Package Type	Pins	SPQ	Unit Array Matrix	Max Temp (°C)	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW (mm)
OMAP L137D ZKB4	ZKB	BGA	256	90	6 X 15	150	315	135.9	7620	19.5	21	19.2

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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